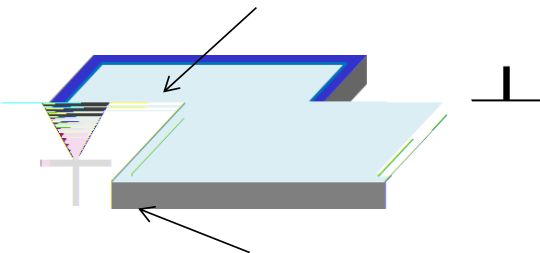


YJ Planar Fast Recovery Diode Die Specification

600V 75A, Fast recovery diode die based on silicon planar process
Part No.: FRD75A600AS-290A

Main Products Characteristics



Maximum Ratings

Parameter	Symbol	Rating
Repetitive peak reverse voltage	V_{RRM}	600V
Average forward current	$I_{F(AV)}$	75A
($t_p = 8.3\text{ ms}$, halfwave, 1 cycle)	I_{FSM}	700A
Storage temperature range	T_{stg}	-40 to +150 °C
Maximum operating junction temperature	T_j	150 °C

Static Electrical Characteristics (Ta = 25°C)

Parameter	Symbol	Value	
		Spec	Typical
Reverse breakdown voltage $I_R = 50\mu\text{A}$	V_{BR}	630V	650V
Maximum forward voltage drop $I_F \leq 2\%$	V_F	1.15V	1.05V
Reverse Recovery Time $I_F = 0.5\text{A}$, $I_R = 1\text{A}$, $I_{rr} = 0.25\text{A}$	T_{rr}	75ns	68ns
Maximum reverse current $V_R = V_{RRM}$ $\leq 2\%$	I_R	2uA	0.05uA

Device Schematics and Outline Drawing

Top Metal Pad

Active Area

Stop Ring

SiO2

Top Metal

Die Size

Back Metal

Substrate

Die Thickness	290um
Die Size *	6600x6600um
Top Metal Pad	5912x5912um
Active Area	5772x5772um
Top Metal	Al
Back Metal	Ag

Note: 1 *: Cutting street width is around 40um

Important Notice

Specification apply to die only. Actual performance may degrade when assembled. does not guarantee device performance after assembly. All operating parameters must be validated for each customer application by customer's technical experts. Data sheet information is subjected to change without notice.	Recommended Storage Environment: Store in original container, in dessicated nitrogen, with no contamination. Shelf life for parts stored in above condition is 2 years. If the storage is done in normal atmosphere shelf life is reduced to 6 months.
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